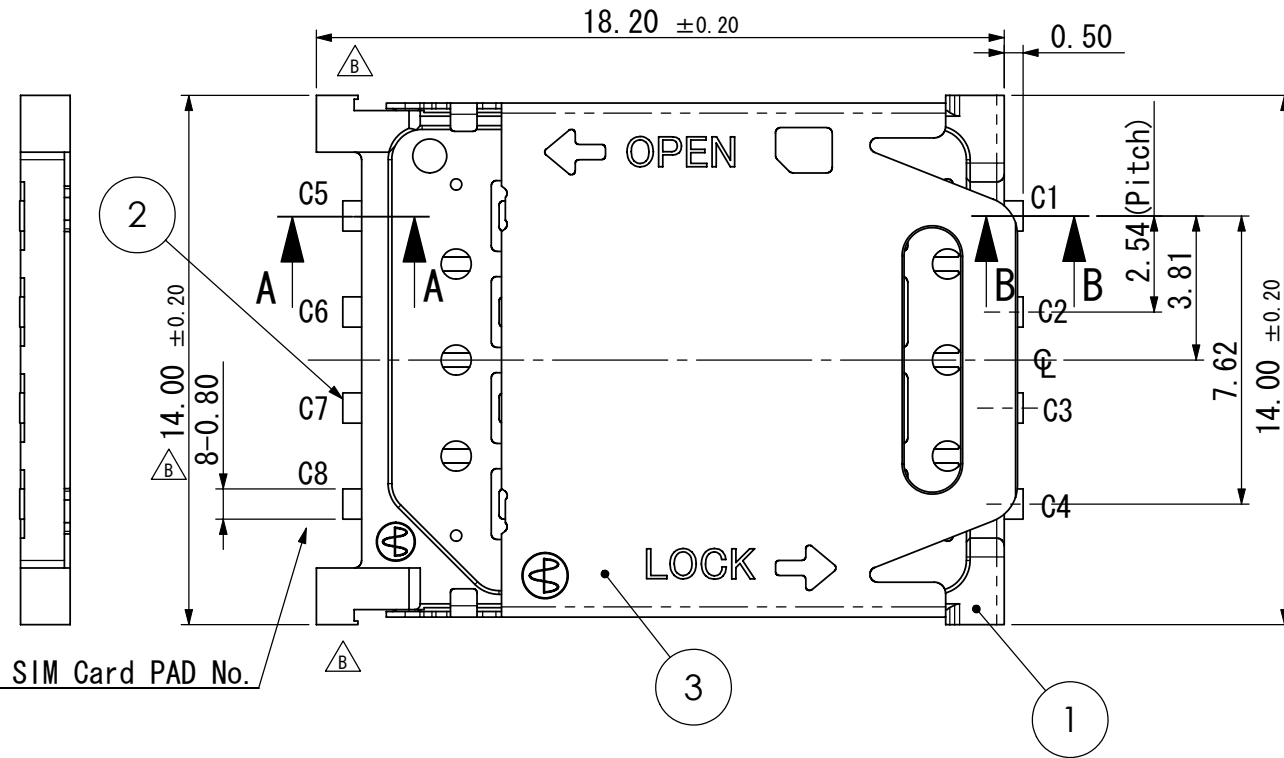
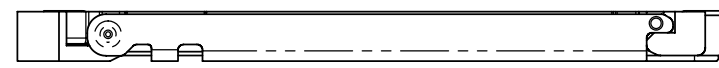
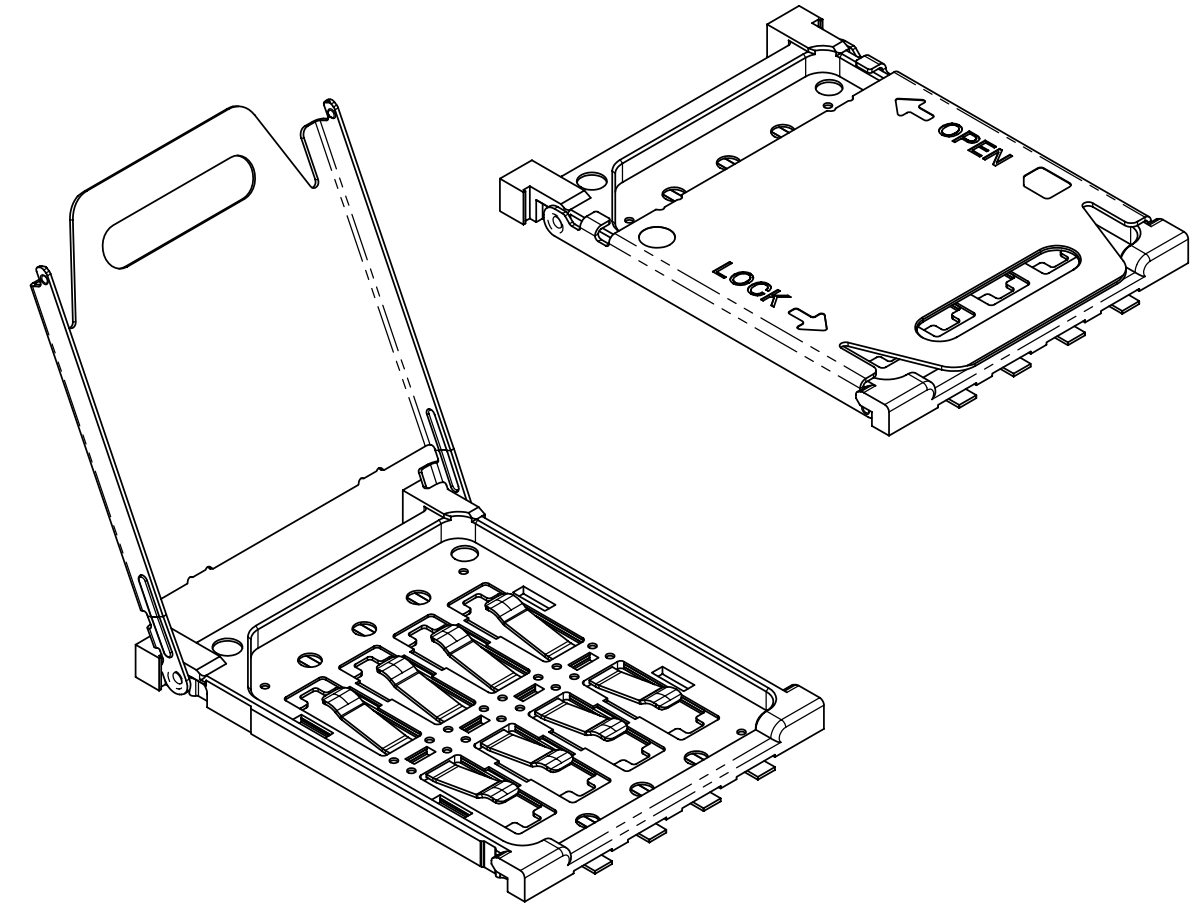


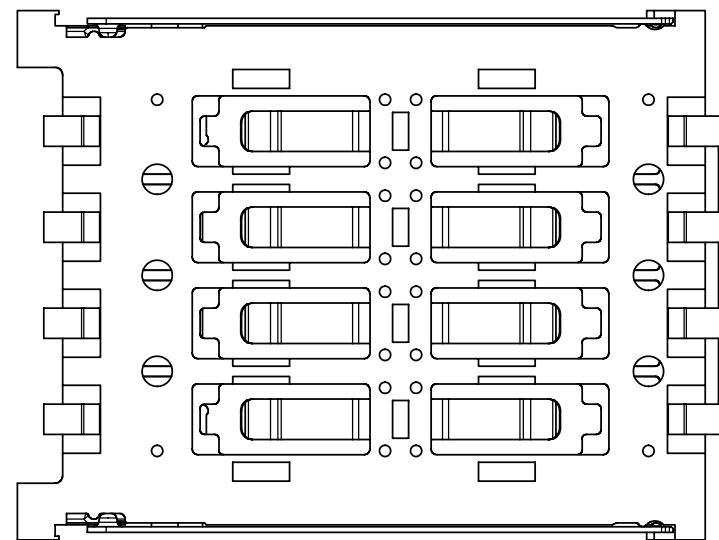
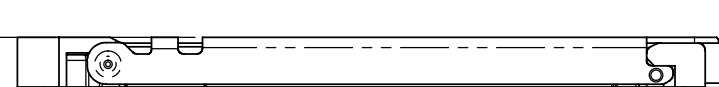
REV.	REVISION DESCRIPTION	APP.	DRW.	DATE	CHANGE No.
△ X 2	design change	K. Abe	O. Shimizu	05/15/11	—
△ X 3	design change	K. Abe	O. Shimizu	07/12/11	YEU-DC0001
△ X					



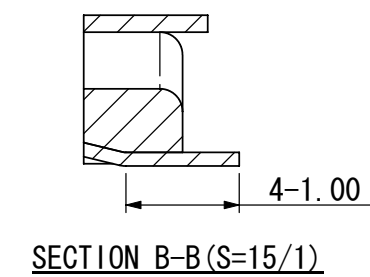
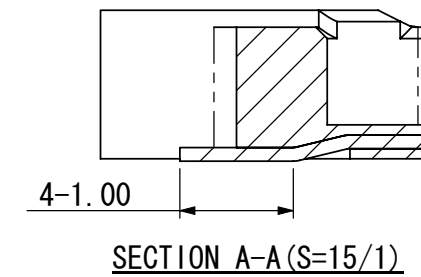
micro SIM Card PAD No.



1.45 max.  
The dimension from bottom of the contact terminals to top surface of metal shell cover.



Contact terminals (8 places)

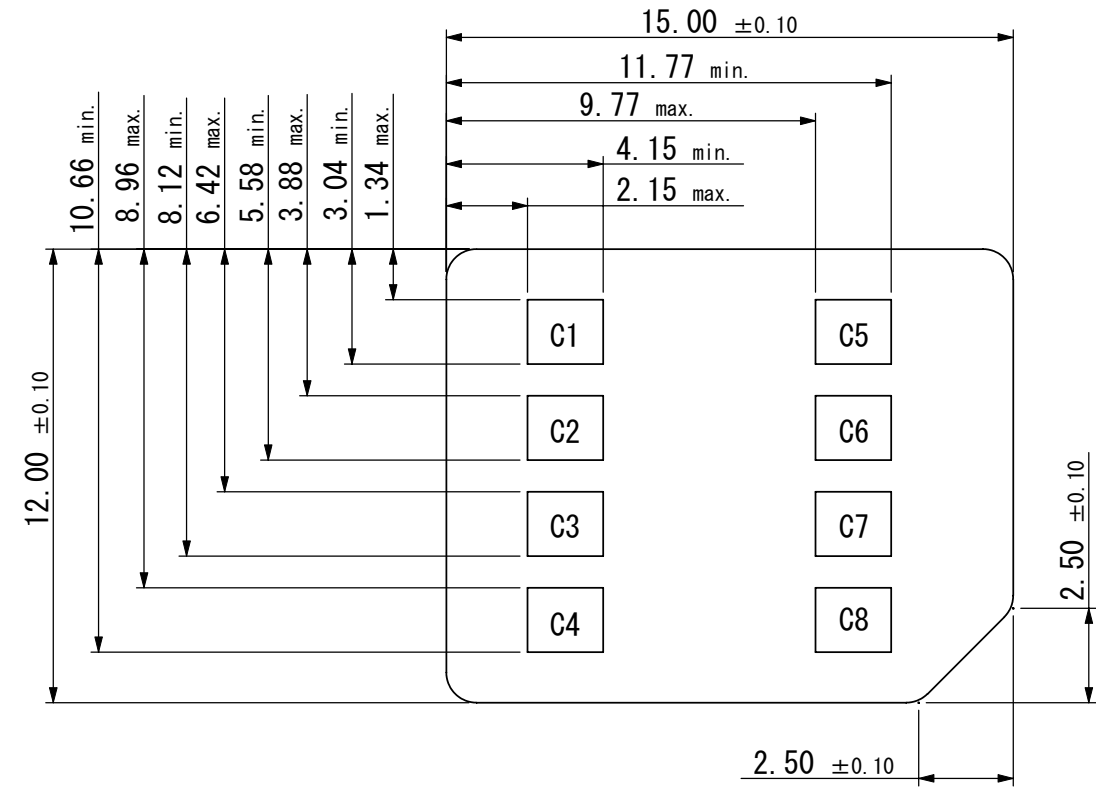
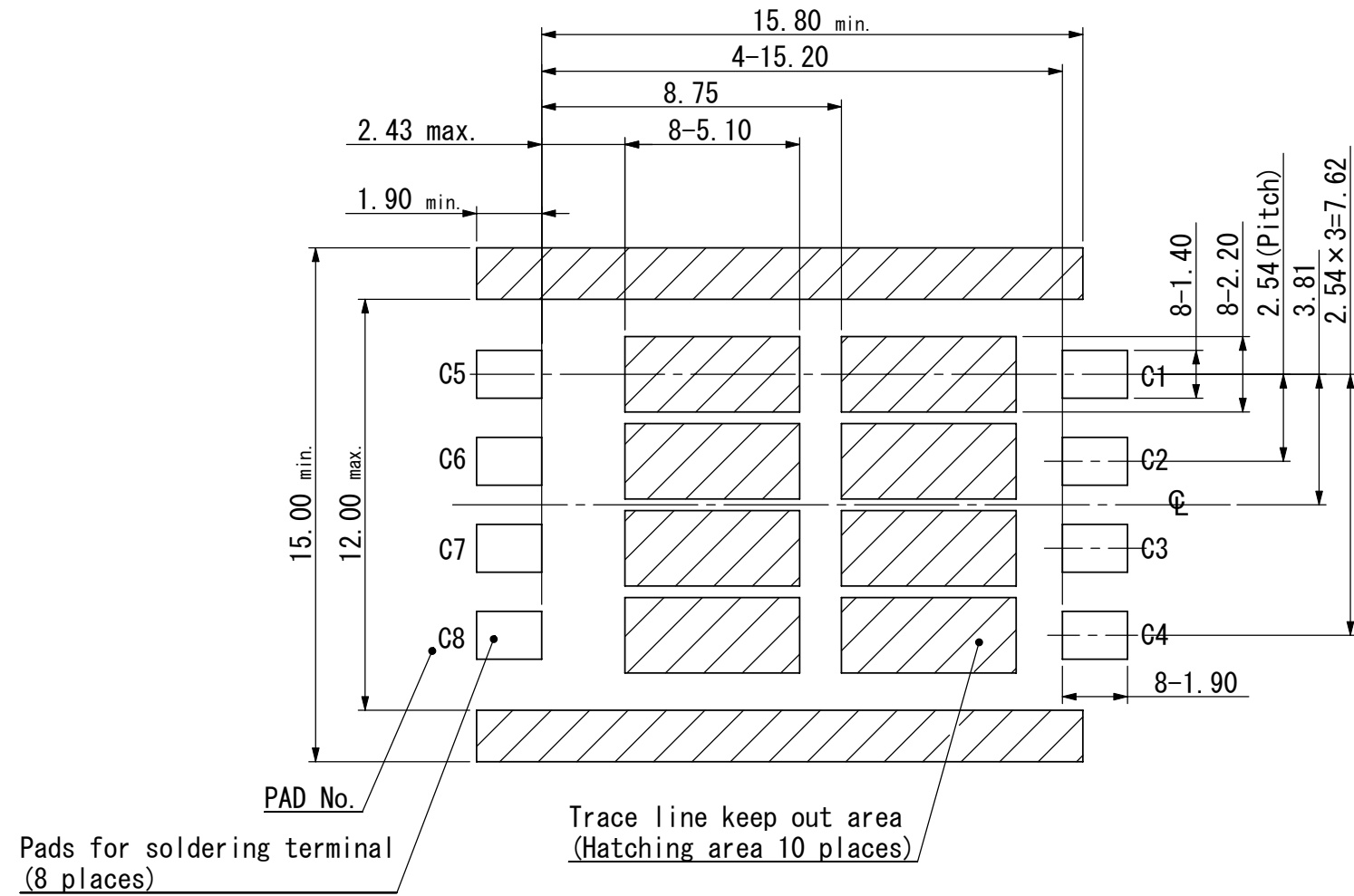


ITEM	DESCRIPTION	QNT.	MATERIAL	NOTE
3	Metal Shell Cover	1	SUS	-
2	Contact Pin	8	PB	Ni-Au
1	Insert Molding	1	LCP	Black

Tolerance ±0.30 Unless otherwise specified. ( )Reference value										
SCALE	5/1	APP.	APP.	CHK.	DRW.	DSGN.	TITLE			
DIMENTION	mm		04/26/11	04/26/11	04/26/11	04/26/11	FUS008U-9000-0			
ANGLE PROJ	3rd		K. Abe	K. Abe	O. Shimizu	O. Shimizu	DRW No.	YEU-A1590	Sheet No.	REV.
								1/2		C

# Recommended PCB Layout (Connector Mounting Side)

Tolerances  $\pm 0.05$  unless otherwise specified



Applicable Card Size

### Note

1.  $\phi$  indicates the centerline of the connector with 14.00mm.
2. Coplanarity for contact terminals shall be 0.10mm maximum.
3. Pin Assignment

1	VCC(Supply voltage)
2	RST(Reset singnail)
3	CLT(Glock signal)
4	Reserved
5	GND(Ground)
6	VPP(Programining voltage)
7	I/O(Data input/output)
8	Reserved

Tolerance $\pm 0.30$ Unless otherwise specified. ( )Reference value							
SCALE	5/1	APP.	APP.	CHK.	DRW.	DSGN.	CLASS
DIMENTION	mm	04/26/11	04/26/11	04/26/11	04/26/11	04/26/11	TITLE
ANGLE PROJ	3rd	K. Abe	K. Abe	O. Shimizu	O. Shimizu		FUS008U-9000-0
						DRW No.	Sheet No. REV.
						YEU-A1590	2/ C